

Technical Session Schedule

Wednesday December 12, 2007				
12:00 - 7:00 PM	<i>Registration - Grand Ballroom Lounge</i>			
Room	<i>Colony Ballroom</i>	<i>Margaret Brent</i>	<i>Jimenez</i>	<i>Carroll</i>
1:30–3:30 PM	WP1: Novel Device Structures	WP2: Space Application and Extreme Environments I	WP3: Oxides and Dielectrics I	WP4: Sensors and Biosensors
3:45–5:35 PM	WP5: Quantum Tunneling and Transport	WP6: Space Application and Extreme Environments II	WP7: Oxides and Dielectrics II	WP8: Modelling Gate Related Effects
6:00–8:30 PM	<i>Welcome Reception and Poster Session - Grand Ballroom</i>			
Thursday December 13, 2007				
7:30 AM - 5:00 PM	<i>Registration - Grand Ballroom Lounge</i>			
Room	<i>Colony Ballroom</i>	<i>Banneker</i>	<i>Jimenez</i>	<i>Carroll</i>
8:00–10:00 AM	TA1: SiC Power Electronic Devices	TA2: Advanced Processing	TA3: Applications of Nanoscale Devices	TA4: Statistical and Technology Modeling
10:15–12:00 PM	TA5: Wide Bandgap Materials	TA6: Silicon on Insulator	TA7: Physics of Nanoelectronic Devices	TA8: Compact Modeling
12:00-1:00 PM	<i>Box Lunch -Grand Ballroom</i>			
1:00–3:30 PM	<i>Plenary Session - Colony Ballroom</i>			
3:45–5:45 PM	TP1: Performance and Reliability of III-Nitride RF Devices	TP2: Si/Ge Devices & Materials	TP3: MEMS	TP4: Device Simulations
6:15–9:15 PM	<i>Symposium Awards Banquet - Grand Ballroom</i>			
Friday December 14, 2007				
Room	<i>Colony Ballroom</i>	<i>Banneker</i>	<i>Jimenez</i>	<i>Carroll</i>
8:00–10:00 AM	FA1: SiC MOS Technology and Issues	FA2: High Frequency I	FA3: Manufacturing Issues of Nanoelectronic Devices	FA4: Organic Materials and Devices
10:15–12:15 PM	FA5: Wide Bandgap Materials	FA6: High Frequency II	FA7: Novel Nanoscale Devices and Device Technologies	FA8: Flexible Electronics
12:15-1:15	<i>Lunch (on your own)</i>			
1:15–3:15 PM	FP1: Photodetectors and Memory Devices	FP2: Optoelectronics: New Detectors and Structures	FP3: Advanced Characterization and Testing I	
3:30–5:30 PM	FP4: Novel Circuits and Devices	FP5: Optoelectronics: New Lasers and Sources	FP6: Advanced Characterization and Testing II	